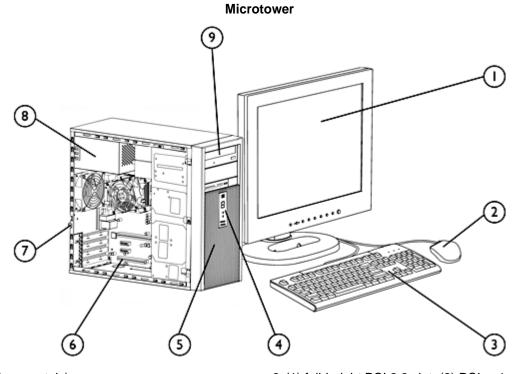
#### Overview

HP recommends Windows® Vista™ Business



- 1. Monitor (sold separately)
- 2. PS/2 Scroll Mouse
- 3. HP Standard Keyboard
- 4. (2) USB 2.0 ports, audio ports
- 5. (2) internal 3.5" drive bays

- 6. (1) full-height PCI 2.3 slot, (2) PCIe x1 slots,
  - (1) PCIe x16 slot
- 7. (4) USB 2.0 ports, (1) serial port, (1) optional second serial port, (1) parallel port, (2) PS/2, (1) RJ-45, (1) VGA, (1) audio in – (1) audio out – (1) MIC
- 8.250-watt max power supply
- 9. (2) external 5.25" drive bays for optional optical drives; (1) external 3.5" drive bay for optional media reader or diskette drive



#### Overview

#### At A Glance

- Intel® Core™ 2 Duo processors, Intel Pentium® D processors, Intel Pentium 4 processors, or Intel Celeron® D processors
- Choice of operating systems:
  - Genuine Windows Vista Business 32
  - Genuine Windows Vista Home Basic 32
  - Genuine Windows XP Professional
  - Genuine Windows XP Home
  - Red Flag Linux (China Only)
  - FreeDOS
- Intel 946GZ Express Chipset
- Intel I/O Controller Hub 7 (ICH7)
- Intel Graphics Media Accelerator 3000
- PCI Express I/O bus
- Serial ATA controller
- Intel PRO/100 VE Network Connection
- Choice of hard drives and optical drives
- DDR2 SDRAM system memory
- Protected by HP Services. Terms and conditions vary by country. Certain restrictions and exclusions apply.



#### Standard Features and Configurable Components

### Processor and SpeedIntel Celeron D ProcessorsOne of the followingIntel Celeron D 331 Processor

Intel Celeron D 331 Processor (2.66-GHz, 256-KB L2 cache, 533-MHz FSB)
Intel Celeron D 336 Processor (2.80-GHz, 256-KB L2 cache, 533-MHz FSB)
Intel Celeron D 347 Processor (3.06-GHz, 512-KB L2 cache, 533-MHz FSB)
Intel Celeron D 352 Processor (3.20-GHz, 512-KB L2 cache, 533-MHz FSB)
Intel Celeron D 356 Processor (3.33-GHz, 512-KB L2 cache, 533-MHz FSB)
Intel Celeron D 360 Processor (3.46-GHz, 512-KB L2 cache, 533-MHz FSB)
Intel Pentium 4 Processors
Intel Pentium 4 531 Processor (3.00-GHz, 1-MB L2 cache, 800-MHz FSB)
Intel Pentium 4 541 Processor (3.20-GHz, 1-MB L2 cache, 800-MHz FSB)
Intel Pentium 4 631 Processor (3.00-GHz, 2-MB L2 cache, 800-MHz FSB)
Intel Pentium 4 641 Processor (3.20-GHz, 2-MB L2 cache, 800-MHz FSB)
Intel Pentium 4 651 Processor (3.40-GHz, 2-MB L2 cache, 800-MHz FSB)
Intel Pentium 4 651 Processor (3.40-GHz, 2-MB L2 cache, 800-MHz FSB)

Intel Pentium D 915 Processor (2.80-GHz, 4-MB L2 cache, 800-MHz FSB) Intel Pentium D 925 Processor (3.00-GHz, 4-MB L2 cache, 800-MHz FSB) Intel Pentium D 935 Processor (3.20-GHz, 4-MB L2 cache, 800-MHz FSB) Intel Pentium D 945 Processor (3.40-GHz, 4-MB L2 cache, 800-MHz FSB)

#### Intel Core 2 Duo Processors

Intel Core 2 Duo E4300 Processor (1.80-GHz, 2-MB L2 cache, 800-MHz FSB) Intel Core 2 Duo E6300 Processor (1.86-GHz, 2-MB L2 cache, 1066-MHz FSB) Intel Core 2 Duo E6400 Processor (2.13-GHz, 2-MB L2 cache, 1066-MHz FSB) Intel Core 2 Duo E6600 Processor (2.40-GHz, 4-MB L2 cache, 1066-MHz FSB) Intel Core 2 Duo E6700 Processor (2.66-GHz, 4-MB L2 cache, 1066-MHz FSB)

\*NOTE: Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor

family, not across different processor families.

Operating Systems and Genuine Windows Vista Business 32\*

Application Software (availability varies by region) Genuine Windows Vista Business 32\* Genuine Windows Vista Home Basic 32\* Genuine Windows XP Professional SP2 Genuine Windows XP Home SP2 Red Flag Linux (China Only) Free DOS

\* **NOTE:** Certain Windows Vista product features require advanced or additional hardware. See <a href="http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx">http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx</a> and <a href="http://www.microsoft.com/windowsvista/getready/capable.mspx">http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx</a> and <a href="http://www.microsoft.com/windowsvista/getready/capable.mspx">http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx</a> and <a href="http://www.microsoft.com/windowsvista/getready/capable.mspx">http://www.microsoft.com/windowsvista/getready/capable.mspx</a> for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit <a href="http://www.windowsvista.com/upgradeadvisor">http://www.windowsvista.com/upgradeadvisor</a>.

Microsoft Office 2007 Basic Microsoft Office 2007 Small Business Microsoft Office 2007 Professional Microsoft Works 8.5



Standard Features	s and Configurable Components	
	Roxio Easy Media Creator 9.1** Intervideo WinDVD Player** Symantec AntiVirus 10 Sun Java Runtime Environment Google Toolbar	
	** Supporting software available with certain optical drive configurations	
Hard Drives	80-GB Serial ATA 3.0-Gb/s Hard Drive (7200 rpm)	
	160-GB Serial ATA 3.0-Gb/s Hard Drive (7200 rpm) 250-GB Serial ATA 3.0-Gb/s Hard Drive (7200 rpm)	
System Memory	256-MB DDR2 Synch DRAM PC2-5300 (667-MHz) Non-ECC (1 x 256-MB) NOTE: 256-MB configurations not supported by Windows Vista	
	512-MB DDR2 Synch DRAM PC2-5300 (667-MHz) Non-ECC (1 x 512-MB)	
	1-GB DDR2 Synch DRAM PC2-5300 (667-MHz) Non-ECC (1 x 1-GB)	
	2-GB DDR2 Synch DRAM PC2-5300 (667-MHz) Non-ECC (2 x 1-GB)	
Storage –	Diskette Drive	
One or more of the	1.44-MB Diskette Drive	
following (see Storage section below)	Media Reader	
	HP 16-in-1 Media Reader and additional USB 2.0 port	
	Optical Drives (Serial ATA)	
	SATA CD-ROM drive (available in APJ only; not supported by Windows Vista)	
	SATA DVD-ROM Drive	
	SATA CD-RW/DVD-ROM Combo Drive (not supported by Windows Vista)	
	SATA DVD+/-RW (DL/DF) LightScribe Drive	
Keyboard –	HP PS/2 Standard Keyboard	
One of the following	HP USB Standard Keyboard	
Mouse –	PS/2 2-Button Scroll Mouse	
One of the following	PS/2 2-Button Optical Scroll Mouse	
	USB 2-Button Optical Scroll Mouse	
Input Devices	Keyboard – One of the following	
	HP PS/2 Standard Keyboard	
	HP USB Standard Keyboard	
	Mouse – One of the following	
	PS/2 2-Button Scroll Mouse	
	PS/2 2-Button Optical Scroll Mouse	
	USB 2-Button Optical Scroll Mouse	



### Standard Features and Configurable Components

Audio	Realtek ALC888 High Definition audio codec 3D audio compliant with AC'97 Rev. 2.3 and HD Audio compatible Internal PC speaker
Communication	Intel PRO/1000 PT Gigabit PCIe Adapter (full height)
	Intel PRO/100 VE Network Connection
	Agere 56K PCI Modem
Graphics	Intel Graphics Media Accelerator 3000
	ATI Radeon X1300 (256MB SH) PCIe Graphics
	ATI Radeon X1300 Pro (256MB DH) PCIe Graphics
Miscellaneous	HP FireWire / IEEE 1394 PCI Card (full height)



#### System Details **Base Unit** Micro ATX microtower chassis, including power supply and front bezel • Five (5) drive bays and four expansion slots Microsoft operating system CD Active type heatsink • 92 x 92 x 25 mm chassis fan System board with Intel 946GZ Express chipset, Intel I/O Controller Hub 7 (ICH7), Intel PRO/100 VE Network Connection, Intel GMA 3000 graphics, and Realtek audio, 1 fullheight PCI 2.3 slot, 2 PCI Express x1 slots, 1 PCI Express x16 slot, 2 DDR2 DIMM memory slots (4) Serial ATA data connectors Product documentation on CD HP system restore CD Power cord Slots PCI One (1) full-height PCI 2.3 slot on PCA Two (2) full-height PCI Express x1 slots on PCA One (1) full-height PCI Express x16 slot on PCA (for graphic cards) Two (2) DDR2 SDRAM DIMM slots (2 GB maximum memory support) Memory Expansion Bays Internal Two (2) 3.5" External Two (2) 5.25" One (1) 3.5" **USB Support** EHCI high-speed USB 2.0 controller Two (2) front ports; Four (4) rear ports, Two (2) internal ports on motherboard Interfaces (Legacy) One (1) parallel port One (1) serial port One (1) optional second serial port One (1) PS/2 keyboard port One (1) PS/2 mouse port One (1) analog VGA video port One (1) line in; one (1) line out; one (1) mic in One (1) RJ45 network port **Chassis Dimensions** Weight & Dimensions 13.90 x 6.89 x 16.38 in (353 x 175 x 416 mm) $(H \times W \times D)$ Packaged Dimensions 22.25 x 19.63 x 16.31 in (565.15 x 498.5 x 414.3 mm) (NA) 21.10 x 19.53 x 15.008 in (536.0 x 496.0 x 383.0 mm) (EMEA) $(L \times W \times H)$ System Weight 21.16 lb (9.6 kg) **Shipping Weight** 30.86 lb (14.0 kg)



System Details		
Technology and Features	Memory Type Hard Drive Interfaces Supported	<ul> <li>PC2-5300 DDR2 SDRAM (667-MHz) non-ECC</li> <li>2 GB maximum system memory</li> <li>Serial ATA</li> </ul>
Chassis	Front Panel	<ul> <li>Power button</li> <li>Power On LED</li> <li>HDD Activity LED</li> </ul>
	Cooling Solutions Supported	<ul> <li>Power Supply Fan (variable speed)</li> <li>Active heatsink (variable speed)</li> <li>Chassis fan (variable speed)</li> </ul>
	Slots Supported	Four (4) full-height expansion slots
	Front I/O	Two (2) USB 2.0 ports
	Rear I/O	Standard Micro ATX I/O connectors, including four (4) USB 2.0 ports
	Drive Bays	<ul> <li>Two (2) 5-1/4" external</li> <li>One (1) 3-1/2" external</li> <li>Two (2) 3-1/2" internal</li> </ul>
	Internal Speaker	Standard
	Security	Padlock loop Kensington Lock Support
	Power Supply	250-watt ATX Power Supply – PFC/non-PFC with a 115v/230v line switch (varies by country/region)
Unit Environment and Operating Conditions	<ul> <li>and cold, to ensur</li> <li>Leave a 4 in (10.2 airflow.</li> <li>Never restrict airfl</li> <li>Do not stack compthey are subject to</li> <li>Occasionally clear computer. Lint, du</li> <li>If the computer is must be provided apply.</li> <li>Temperature Range</li> </ul>	<ul> <li>er away from excessive moisture, direct moisture and the extremes of heat e that unit is operated within the specified operating range.</li> <li>e cm) clearance on all vented sides of the computer to permit the required ow into the computer by blocking any vents or air intakes.</li> <li>pouters on top of each other or place computers so near each other that b each other's re-circulated or preheated air.</li> <li>In the air vents on the front, back, and any other vented side of the list and other foreign matter can block the vents and limit the airflow.</li> <li>to be operated within a separate enclosure, intake and exhaust ventilation on the enclosure, and the same operating guidelines listed above will still</li> <li>Operating: 50° to 95° F (10° to 35° C)</li> <li>Non-operating: -22° to 140° F(-30° to 60° C)</li> </ul>
	Relative Humidity	<ul> <li>Operating: 10% to 90% (non-condensing at ambient)</li> <li>Non-operating: 5% to 95% (non-condensing at ambient)</li> </ul>
	Maximum Altitude (unpressurized)	<ul> <li>Operating: 10,000 ft (3048 m)</li> <li>Non-operating: 30,000 ft (9000 m)</li> </ul>
	above sea level, no dire	erature is de-rated 1.0 deg C per 1000 ft (300 m) to 10,000 ft (3000 m) ct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper ne type and number of options installed.

System Board

- Processor
- Socket T; LGA775 industry standard Micro ATX form factor



### System Details

	<ul> <li>Support single Intel Core 2 Duo, Pentium D, Pentium 4 or Celeron D</li> </ul>
PWM	Intersil 6312 3 phase
Chipset	<ul><li>Intel 946GZ Express</li><li>Intel I/O Controller Hub 7 (ICH7)</li></ul>
Super I/O	• W83627DHG
Front Side Bus Frequency	• 533/800 MHz
Memory	<ul> <li>DDR2 SDRAM</li> <li>2 x DIMM slots</li> </ul>
Clock Generator	• CY505YC56DT
Integrated Graphics	<ul> <li>Intel Graphics Media Accelerator (GMA) 3000</li> </ul>
Audio	<ul> <li>Realtek ALC888 HD Audio compatible codec with two channel audio 3D audio compliant with AC'97 rev. 2.3</li> </ul>
LOM	<ul> <li>Intel PRO/100 VE Network Connection</li> </ul>
IDE	Support all PIO modes
	<ul><li>1 x IDE ports support up to 2 devices</li><li>Support Ultra ATA 33/66/100</li></ul>
Serial	Four Serial ATA interfaces
Expansion Slots	<ul> <li>1 x PCI 2.3 slot</li> <li>2 x PCI Express x1 slots</li> <li>1 x PCI Express x16 slot</li> </ul>
BIOS	LPC EEPROM
Industrial Standard	<ul><li>PCI 2.3 compliant</li><li>USB 2.0</li></ul>
Rear Side I/O Ports On Board I/O Interfaces	<ul> <li>1 x PS/2 keyboard port</li> <li>1 x PS/2 mouse port</li> <li>4 x USB 2.0 ports</li> <li>1 x RJ-45 10/100 port</li> <li>1 x serial port</li> <li>1 x optional second serial port</li> <li>1 x parallel port</li> <li>1 x DB 15 pin analog VGA port</li> <li>3 x audio ports</li> <li>1 x ATX power connector</li> <li>1 x +12V power connector</li> <li>1 x Floppy connector</li> </ul>
Board Size	<ul> <li>1 x Front panel connector, Switch, LED (ON/Flash/OFF)</li> <li>2 x Fan headers for CPU, chassis, with voltage/fan speed control</li> <li>1 x header to support 2 USB 2.0 ports at front side</li> <li>1 x header to support USB media reader</li> <li>1 x serial header to support optional second serial port</li> <li>Micro-ATX, PCB Size: 9.6 x 9.0 in (24.38 x 22.86 cm)</li> <li>4-layer PCB with green color</li> </ul>



Additional Features	<ul> <li>Bootable without keyboard, mouse or monitor</li> <li>Keyboard/mouse/USB wake up</li> <li>Support S1, S3, S4 and S5</li> <li>ACPI status</li> <li>Hardware monitor capability</li> <li>CPU fan speed control</li> </ul>	
	Intel PRO/100 VE Network Connection	
Hardware Highlights	PCI interfaces	
Features	<ul> <li>10-Mbps and 100-Mbps operation</li> </ul>	
	Intel PRO/1000 PT Gigabit PCIe Adapter	
Hardware Highlights	PCI Express interface	
Features	<ul> <li>10-Mbps, 100-Mbps and 1000-Mbps operation</li> </ul>	
Wireless A+G PCI Card (full height bracket)		
<ul> <li>ATX Power Supply – Passive PFC/non-PFC with a 115v/230v line switch</li> <li>Passive Power Factor Correction (PFC) – with line switch set to 230V – No PFC in 115V line switch position</li> <li>90 to 140VAC, or 180 to 264VAC operating voltage range</li> <li>100 to 127VAC, or 200 to 240VAC rated voltage range</li> <li>50–60 Hz rated line frequency</li> <li>47–63 Hz operating line frequency range</li> <li>250 watt maximum rated power</li> <li>80-mm power supply fan – variable speed for optimum acoustics</li> </ul>		
<ul> <li>System Idle mode</li> <li>~2 watt power col</li> </ul>		
	Hardware Highlights Features Hardware Highlights Features Wireless A+G PCI Card • ATX Power Supp • Passive Power Faswitch position • 90 to 140VAC, or • 100 to 127VAC, or • 50–60 Hz rated lift • 47–63 Hz operation • 250 watt maximum • 80-mm power sup • APM 1.2 support • Screen blanking • Hard drive 'Idle' m • System Idle mode • ~2 watt power com	



System Details				
System Environmental Specs	<ul> <li>Values are subject to change without notification and are for reference only.</li> <li>Performance of system, options, and ancillary equipment will vary depending on the system configuration.</li> <li>Levels presented do not account for non-HP/Compag installed hardware.</li> </ul>			
	Ambient Air Temperature	Operating	50° to 95°F (10° to 35°C) at sea level with an altitude de-rating of 1.0°C per every 1000 ft (300 m) above sea level to a maximum of 8000 ft (2500 m), no direct sustained sunlight. Maximum rate of change is 77°F/Hr (25°C/Hr). The upper limit may be limited by the type and number of options installed.	
		Storage	-22° to 140°F (-30° to 60°C) – Maximum rate of change: 410°F/Hr (210°C/Hr).	
	Humidity	Operating	10% to 90% relative humidity (Rh), 86°F (30°C) maximum wet bulb temperature, non- condensing	
		Storage	10% to 95% relative humidity (Rh), 101.66°F (38.7°C) maximum wet bulb temperature, non-condensing	
	Altitude	Operating	0 to 10,000 feet (0 to 3048 meters) – This value may be limited by the type and number of options installed. Maximum allowable altitude change rate is 1,000 ft/min (304.8 m/min).	
		Non-Operating	0 to 30,000 feet (0 to 9,144 meters) – Maximum allowable altitude change rate is 1200 ft/min (365.76 m/min).	
	Shock	damage being incurre	of shock the product can withstand with NO ed. The values represent peak input acceleration If-sine shock pulse, 11 ms trapezoidal shock pulse.	
		Non-Operating	35G's (Half-sine Shock) 35G's (Trapezoidal Shock)	
	Vibration	damage being incurre	of vibration the product can withstand with NO ed. The values represent a flat random vibration ofile across the given frequency range.	
		Operating	Random vibration at 5Hz@0.00025G <sup>2</sup> /Hz, 10Hz@0.01G <sup>2</sup> /Hz, 100Hz@0.01G <sup>2</sup> /Hz, 300Hz@0.00001G <sup>2</sup> /Hz 5Hz to 300Hz, (0.25G's nominal).	
		Non-Operating	Random vibration at 0.008G²/Hz, 10Hz to 500Hz, (2 Grms nominal).	



#### System Details

Acoustic Noise	(LWAd) and declared av WEIGHTED SOUND PR operating in a 73.4°F (23	A-WEIGHTED SOUND POWER LEVELS erage desktop seated operator position A- ESSURE LEVELS (LpAm) when the product is B°C) ambient environment. Noise emissions dance with ISO 7779 (ECMA 74) and declared 0296 (ECMA 109).
	IDLE (Fixed disk drive spinning)	LWAd = 4.3 Bels, Desktop Average LpAm = 32 dBA
	FIXED DISK (Random write)	LWAd = 4.8 Bels, Desktop Average LpAm = 37dBA
	CD-ROM (Sequential	LWAd = 5.0 Bels,

Deskside Average LpAm = 39dBA

Service and Support

On-site Warranty<sup>Note 1</sup>: One-year (1-1-1) limited warranty delivers one year of on-site, next business-day<sup>Note 2</sup> service for parts and labor and includes free telephone support<sup>Note 3</sup> 24 x 7. Global coverage<sup>Note 2</sup> ensures that any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. One-year onsite and labor are not available in all countries.

Reads)

**NOTE 1:** Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

**NOTE 2:** On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

**NOTE 3:** Technical telephone support applies only to HP-configured Compaq and third-party HPqualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.



### After-Market Options

Communications	NICs	
	Intel PRO/1000 PT Gigabit PCIe Adapter (full height)	EH352AA
	Wireless LAN	
	HP Wireless A+G PCI Card (North America only)	EA118AA
	HP Wireless A+G PCI Card (WW except North America)	PZ928AA
	Modems	
	Agere 2006 PCI High-Speed 56K International SoftModem	EK694AA
Hard Disk Drives	HP 250-GB SATA 3.0-Gb/s Hard Drive	PY278AA
	HP 160-GB SATA 3.0-Gb/s Hard Drive	PY277AA
	HP 80-GB SATA 3.0-Gb/s Hard Drive	PY276AA
Removable Storage	Diskette Drive	
Devices	HP 1.44-MB Internal Diskette Drive	AG295AA
	HP 1.44-MB USB Diskette Drive – External	DC141B
	16-in-1 Media Reader	EM718AA
	USB Drive Key	
	HP 1-GB Drive Key II Flash Drive	AG382AA
	HP (APJ) 512-MB Drive Key II Flash Drive	ED516AA
Input Devices	Keyboards	
	HP PS/2 Standard Keyboard	DT527A
	HP USB Standard Keyboard	DT528A
	Mice	
	HP PS/2 2-Button Scroll Mouse	DD440B
	HP PS/2 2-Button Optical Scroll Mouse	EY703AA
	HP USB 2-Button Optical Scroll Mouse	DC172B
Memory	HP 1-GB PC2-5300 (DDR2-667 MHz) DIMM	PX976AA
	HP 512-MB PC2-5300 (DDR2-667 MHz) DIMM	PX975AA
	HP 256-MB PC2-5300 (DDR2-667 MHz) DIMM	PX974AA
	<b>NOTE:</b> The HP Compaq dx2300 Microtower memory frequency is clocked at 630 MHz.	
Audio	HP Satellite Speakers	ZD929AA
Graphics	ATI Radeon X1300 Pro (256MB DH) PCIe Graphics	AH050AT



After-Market Op	tions	
<b>Optical Drives</b>	HP SATA CD-ROM Drive (available in Asia Pacific and Japan only)	AH045AA
	HP SATA CD-RW/DVD-ROM Combo Drive	AH046AA
	HP SATA DVD-ROM Drive	AH047AA
	HP SATA DVD+/-RW (DL/DF) LightScribe Drive	AH048AA
Security	HP Business PC Security Lock Kit	PV606AA
Miscellaneous Accessories	HP FireWire / IEEE 1394 PCI Card	
Monitors	CRTs	
	HP s7540 17" (16.0" vis) CRT Monitor	PF997AA#XXX
	HP v7650 17" (16.0" vis) Flat-face CRT Monitor	PF996AA#XXX
	TFTs	
	HP L1506 15" TFT Flat Panel Monitor – Analog only	PX848AA#XXX
	HP L1706 17" TFT Flat Panel Monitor – Analog only	PX849AA#XXX
	HP L1740 17" TFT Flat Panel Display – Analog/Digital	PL766AA#XXX
	HP L1755 17" TFT Flat Panel Display – Analog/Digital	PL777AA#XXX
	HP L1906 19" TFT Flat Panel Display – Analog only	PX850AA#XXX
	HP L1940T 19" TFT Flat Panel Display – Analog/Digital	EM869AA#XXX
	HP L1955 19" TFT Flat Panel Display – Analog/Digital	PD974AA#XXX
	HP L2065 20" TFT Flat Panel Display – Analog/Digital	EF227A4#XXX
	HP LP2465 24" TFT Widescreen Flat Panel Display – Analog/Digital	EF224A4#XXX
	GSA Monitors	
	HP L717g 17" GSA Flat Panel Monitor	EE191AA#ABA
	HP L919g 19" GSA Flat Panel Monitor	EE192AA#ABA
	Options	
	HP Flat Panel Speaker Bar	EE418AA
	HP CRT Monitor Multimedia Base	PM552AA



Memory

#### DDR SYNCH DRAM NON-ECC MEMORY

The Intel 946GZ Express chipset supports non-ECC DDR2 memory up to PC2-5300 (667-MHz). Memory upgrades are accomplished by adding single or multiple DIMMs of the same or varied sizes. This chart does not represent all possible memory configurations.

**CAUTION:** You must shut down the computer **and disconnect the power cord** before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

#### HP recommends dual-channel symmetric configurations for maximum performance.

For best performance, add the same amount of total memory to each channel and do not mix speeds. For dual-channel symmetric performance, the total amount of memory in each channel must be equal. If speeds are mixed, speed will default to the slowest DIMM.

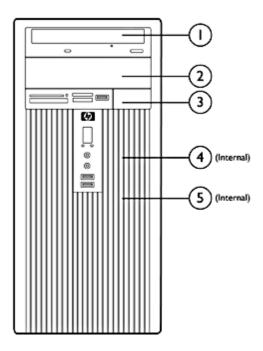
#### MAXIMUM MEMORY

Supports up to 2-GB of DDR2 SYNCH DRAM. Not all memory configurations possible are represented below.

DIMM Size	Slot 1	Slot 2
256-MB	256-MB	
512-MB	512-MB	
512-MB (dual-channel symmetric)	256-MB	256-MB
1-GB	1-GB	
1-GB (dual-channel symmetric)	512-MB	512-MB
2-GB (dual-channel symmetric)	1-GB	1-GB



Storage



### HP Compaq dx2300 Microtower Business PC

	Maximum Quantity Supported	Position Supported	Controller
Drive Support			
Diskette Drives	1	3	SIO
Media Reader	1	3	Internal USB 2.0 port
CD-ROM Drives	2	1, 2	IDE ATAPI
DVD-ROM Drives	2	1, 2	IDE ATAPI
CD-RW/Combo Drives	2	1, 2	IDE ATAPI
DVD+/-RW Drives	2	1, 2	IDE ATAPI
3.5" Serial ATA Hard Drives	2	4,5	SATA



Technical Specifications - Audio

Integrated Realtek ALC888 Audio	Type HD Audio compatible codec	Integrated Yes
	Sampling	Supports 48/96 KHz
	Audio Jacks	Mic-In
		Line-In
		Line-Out / Headphone Out
	Power Support	Digital: 3.3V
		Analog: 5V
	Other	Meets performance requirements for audio on PC99/2001 systems High-performance DACs with 97dB SNR(A-Weighting) ADCs with 90dB NR(A-Weighting)



### Technical Specifications - Communications

Intel PRO/1000 PT PCIe	Connector	RJ-45
Gigabit NIC	Controller	Intel 82572EI Gigabit Ethernet Controller
	Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers
	Data rates supported	10/100/1000 Mbps
	Compliance	IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x flow control
	Bus architecture	PCI Express 1.0a
	Data transfer mode	Bus-master DMA
	Hardware certifications	FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union
	Power requirement	Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T
	Boot ROM support	Yes
	Network transfer rate	10BASE-T (half-duplex) 10 Mbps
		10BASE-T (full-duplex) 20 Mbps
		100BASE-TX (half-duplex) 100 Mbps
		100BASE-TX (full-duplex) 200 Mbps
		1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)
	Environmental	<b>Operating temperature</b> 32° to 131°F (0° to 55° C)
		<b>Operating humidity</b> 85% at 131° F (55° C)
	Dimensions	6.4 x 2.6 x 0.8 in (16.3 x 6.6 x 1.9 cm)
	Management capabilities	ASF, WOL, PXE, DMI, WFM 2.0.
HP Wireless A+G PCI	Dimensions	4.99 x 2.54 x 0.71 in (126.8 x 64.4 x 18.0 mm)
HP Wireless A+G PCI	Dimensions Weight	4.99 x 2.54 x 0.71 in (126.8 x 64.4 x 18.0 mm) 0.268 lb (65 g)
HP Wireless A+G PCI		
HP Wireless A+G PCI	Weight Controller	0.268 lb (65 g) Atheros AR5414X chipset
HP Wireless A+G PCI	Weight Controller system interface	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2
HP Wireless A+G PCI	Weight Controller system interface Network standard	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g
HP Wireless A+G PCI	Weight Controller system interface Network standard	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g 5.1500 to 5.8500 GHz
HP Wireless A+G PCI	Weight Controller system interface Network standard Frequency band	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g 5.1500 to 5.8500 GHz 2.4000 to 2.4835 GHz 2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific – excluding Japan) 2.4000 to 2.4697 GHz (Japan)
HP Wireless A+G PCI	Weight Controller system interface Network standard Frequency band	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g 5.1500 to 5.8500 GHz 2.4000 to 2.4835 GHz 2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific – excluding Japan) 2.4000 to 2.4697 GHz (Japan) 32° to 140° F (0° to 60° C), operating
HP Wireless A+G PCI	Weight Controller system interface Network standard Frequency band Operating temperature Storage temperature	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g 5.1500 to 5.8500 GHz 2.4000 to 2.4835 GHz 2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific – excluding Japan) 2.4000 to 2.4697 GHz (Japan) 32° to 140° F (0° to 60° C), operating -4° to 176° F (-20° to 80° C), non-operating
HP Wireless A+G PCI	Weight Controller system interface Network standard Frequency band Operating temperature Storage temperature Humidity	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g 5.1500 to 5.8500 GHz 2.4000 to 2.4835 GHz 2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific – excluding Japan) 2.4000 to 2.4697 GHz (Japan) 32° to 140° F (0° to 60° C), operating -4° to 176° F (-20° to 80° C), non-operating 10% to 85% non-condensing
HP Wireless A+G PCI	Weight Controller system interface Network standard Frequency band Operating temperature Storage temperature Humidity Operating voltage	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g 5.1500 to 5.8500 GHz 2.4000 to 2.4835 GHz 2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific – excluding Japan) 2.4000 to 2.4697 GHz (Japan) 32° to 140° F (0° to 60° C), operating -4° to 176° F (-20° to 80° C), non-operating 10% to 85% non-condensing $5V \pm 5\%$
HP Wireless A+G PCI	Weight Controller system interface Network standard Frequency band Operating temperature Storage temperature Humidity Operating voltage Power consumption	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g 5.1500 to 5.8500 GHz 2.4000 to 2.4835 GHz 2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific – excluding Japan) 2.4000 to 2.4697 GHz (Japan) 32° to 140° F (0° to 60° C), operating -4° to 176° F (-20° to 80° C), non-operating 10% to 85% non-condensing $5V \pm 5\%$ Tx/Rx peak 560/250mA @ 3.3V (max.)
HP Wireless A+G PCI	Weight Controller system interface Network standard Frequency band Operating temperature Storage temperature Humidity Operating voltage	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g 5.1500 to 5.8500 GHz 2.4000 to 2.4835 GHz 2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific – excluding Japan) 2.4000 to 2.4697 GHz (Japan) 32° to 140° F (0° to 60° C), operating -4° to 176° F (-20° to 80° C), non-operating 10% to 85% non-condensing $5V \pm 5\%$
HP Wireless A+G PCI	Weight Controller system interface Network standard Frequency band Operating temperature Storage temperature Humidity Operating voltage Power consumption Output power	0.268 lb (65 g) Atheros AR5414X chipset PCI Spec 2.2 IEEE 802.11a/b/g 5.1500 to 5.8500 GHz 2.4000 to 2.4835 GHz 2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific – excluding Japan) 2.4000 to 2.4697 GHz (Japan) 32° to 140° F (0° to 60° C), operating -4° to 176° F (-20° to 80° C), non-operating 10% to 85% non-condensing $5V \pm 5\%$ Tx/Rx peak 560/250mA @ 3.3V (max.)



### Technical Specifications - Communications

	Spreading	DSSS (Direct Sequence	Sproad Spootrum)
	Security		
	Security	Microsoft PEAP, TKIP, W	it, WPA, IEEE802.1X, AES-OCB, AES-CCM, /EP
	Antenna	External 5dBi antenna	
	Throughput	<b>108 Mbps</b> (only with Belkin 54G or above router that supports 108 Mbps speed)	200 ft (60.96 m) – Indoor
		54 Mbps	200 ft (60.96 m) – Indoor
		11 Mbps	200 ft (60.96 m) – Indoor
	Certifications	Wi-Fi certified	
	Certifications for use	North America: United St	tates, Canada
	by country	Greece, Iceland, Ireland,	n, Cyprus, Denmark, Finland, France, Germany, , Italy, Liechtenstein, Luxembourg, Netherlands, , Sweden, Switzerland, United Kingdom
Agere 56K PCI Modem	Data Transmission	56 000 Kbps maximum d	lownstream data
Agere Son PCI Modern		56,000 Kbps maximum downstream data <b>NOTE:</b> 56 Kbps technology refers to download speeds only and requires compatible modems at server sites. Other conditions may lin modem speed. FCC limitations allow a maximum of 53 Kbps during download transmissions.	
	Data Speeds	(Upload only)	5,400/21,600/19,200/16,800/14,400/
	Data Standards	ITU-T V.90, ITU-T, ITU-T 212A, and Bell 103	V.34, V.44, V.42, V.42bis21, V.32bis, Bell
	Fax Speeds	14,400/12,000/9,600/7,2	00/4,800/2,400/300 b/s
	Fax Mode Capabilities	ITU-T T.31 class 1 FAX,	V. 17, V.29, V.27ter, and V.21 Channel 2
	Error Correction and Data Compression	V.44, 42bis, V.42 and MI	NP2-5
	Power Management	ACPI; PPMI 1.1 and wak requirements and PC 200	e support with PME and Vaux; meets PCI 2.3 01 requirements
	Upgradeability	Driver upgradeable for fu	iture enhancements
	Video	ITU-T V.80 video ready in	nterface
	Other	TIA/EIA 602 standard AT	command set
		Integrated DTE interface 16550a UART-compatibl	with speeds of up to 115.2 Kbps, parallel e interface
		Optional ring wakeup sig	nal
	<b>Operating Temperature</b>	32° to 158° F (0° to 70°	C)
	Operating Humidity	20% to 90%, non-conder	nsing
	Power	Requires a 3.3-V auxiliar	y power rail on PCI bus
		Uses only one PCI load ( one electrical load	(i.e., one grant/request pair), one shared IRQ,



### Technical Specifications - Communications

Chipset	Agere Systems SV92PL – Integrated PCI interface with 5-V tolerant buffers and CardBus support
Dimensions (L X H)	Complies with PCI low profile specifications-6.7 x 2.3 in (17.0 x 5.8 cm) and supports high- and low-profile brackets
Connection	Single RJ-11 connector
Other Features	Digital line protection, call progress monitoring via on-board piezo device, support for high profile and low profile brackets, PnP ID support
Safety	UL recognized to UL 1950, 3rd edition (U.S. and Canada); IEC 950 (TUV, NEMKO, DEMKO, SEMKO); CE Mark, EC 950 (TUV, NEMKO, DEMKO, SEMKO, CE mark
EMC	FCC Part 15, IC ES003, EN 55022, 3rd edition, EN 55024, annex A, EN 61000-4-6, EN 61000-4-8
Telecom	FCC Part 68, IC-CS-03 (Canada); Worldwide PTT approvals Not available in Korea or the Republic of South Africa.
Health	Bare PCB material compliant to 94V-0 or better (marked as such)
Other	PC 2001 compliant, PCI version 2.3, WHQL approved; ACPI compliant



Technical Specifications - Graphics					
Integrated Graphics Media Accelerator 3000	3D/2D Controller	Microsoft DirectX® 9 based with support for Pixel Shader 2.0, 4:1 anisotropic filtering, Gaussian texture filtering, shadow maps, volume textures, double-sided stencil buffers, and 4 pixel pipes.			
	VGA Controller	Integrated			
	Bus Type	PCI Express <sup>™</sup> x16 (If an external graphic slot, the internal graphics can be enabled BIOS setup utility. If an external graphics Express <sup>™</sup> slot, the internal graphics can	or disabled using the system's card is installed in the PCI		
	RAMDAC	Integrated, 400 MHz			
	Memory	Graphics memory is shared with system r usage varies depending on the amount of system load. 8 MB is pre-allocated for graphic Additional memory is allocated for graphic Dynamic Video Memory Technology (DVI balance between graphics and system me	f system memory installed and aphics use at system boot time. cs as needed using Intel's MT), to provide an optimal		
		System memory equal or greater than a SMR pro ellegated + 248 MR DV/MT - me			
	Controller Cleak Speed	8 MB pre-allocated + 248 MB DVMT = max frame buffer of 256 MB			
	Controller Clock Speed				
	Overlay Planes	Single overlay support with 5x3 filtering			
	Maximum Color Depth	·			
	Maximum Vertical Refresh Rate	85 Hz at up to 1920x1440, 85 Hz at 2048x1536. Varies with mode and configuration. See table below.			
	Multi-display Support	Support for one CRT via the motherboard an additional DVI-D display via the option independent displays and dual synchrono displays are supported.	al DVI ADD2 card. Dual		
	Graphics/Video API Support	Microsoft DirectX®9, DirectXVA®, VMR9	, GDI/GDI+; OpenGL® 1.4.		
Resolutions	Resolution	Maximum Refre	esh Rate (Hz)		
Supported <sup>1</sup>		Analog Monitor	Digital Monitor		
	640 x 480	85	60		
	800 x 600	85	60		
	1024 x 768	85	60		
	1280 x 1024	85	60		
	1600 x 1200	85	60		
	1920 x 1080	85	60		

<sup>1</sup> Modes listed are supported with a single active display. The supported mode list for multiple active displays is a subset of this list. Not all modes will support video playback and some supported modes may use software MC (motion compensation) rather than hardware MC. Not all modes will support 3D acceleration depending on the system configuration (e.g., resolution selected, size of frame buffer, number of installed memory modules, etc.).

85

85

85

NOTE: Other resolutions and refresh rates may be selectable but are not recommended.

1920 x 1200 1920 x 1440

2048 x 1536



60

60

60

Technical Specifications - Graphics

ATI Radeon X1300	Bus type	PCI Express (x16 lanes)		
(256MB SH) PCle Graphics Card	Maximum vertical refresh rate	85 Hz		
(256 MB)	Display support	Integrated 400 MHz RAMDAC		
	Display max resolution	2048 x 1536		
	Board display options	DVI-I + TV DVI-I supports analog CRT or flat panel or digital flat panel (using DVI- A, DVI-D or DVI-I connector) DVI-I supports analog CRT or flat panel (with VGA connector and DVI-I to VGA dongle)		
		TV connector is a 4-pin mini-DIN S	S-video connector	
	Board configuration	Specification	Description	
		Graphics Chip	RV515	
		Core clock	450 MHz	
		Memory clock	250 MHz	
		Frame buffer	256 MB DDR2	
	Languages supported	24 languages: English, Arabic, Ch Czechoslovakian, Danish, Dutch, H Hebrew, Hungarian, Italian, Japan Portuguese, Russian, Spanish, Sw	ese, Korean, Norwegian, Polish,	
	Core power	25 W (Max board power)		
	Option kit contents	<ul> <li>ATI RADEON X1300 PCIe g attached</li> <li>Low profile bracket</li> <li>DVI-to-VGA Adapter</li> <li>Software CD with graphics d</li> <li>Warranty documentation</li> </ul>	raphics card with full height bracket	
	Compliance standards	<ul> <li>ds EMC Emissions: <ul> <li>a) FCC Part 15, Subpart B – Unintentional Radiators, Class B Computing Devices for Home &amp; Office Use</li> <li>b) CISPR22: 1997/EN 55022:1998 – Class B – Limits and met measurement of radio disturbance characteristics of Informatic Technology Equipment</li> <li>c) Canadian Standard ICES-003 is equivalent to CISPR22</li> <li>d) Taiwanese Standard BSMI</li> <li>e) Japanese VCCI</li> <li>f) Australian C-Tick</li> </ul></li></ul>		
		EMC Immunity: CISPR 24:1997/EN 55024:1998 – Immunity Characteristics – Limits a	Information Technology Equipment – and Methods of Measurement.	
			): Safety of Information Technology siness Equipment. All boards meet 	



Technical Specifications - Graphics

ATI Radeon X1300 Pro	Bus Type	PCI Express (x16 lanes)	
(256MB DH) PCIe Graphics Card	Maximum Vertical Refresh Rate	85 Hz	
	Display Support	Integrated 400 MHz RAM	MDAC
	<b>Display Max Resolutior</b>	<b>า</b> 2048 x 1536	
	Board Display Options	monitors via optional DM	ncluded DMS-59 to dual VGA cable or 2 DVI IS-59 to dual DVI monitor kit #DL139A. <i>v</i> ia 7 pin mini Din S-video connector
	<b>Board Configuration</b>	Specification	Description
	128 MB Frame Buffer	Graphics Chip	RV516
		Core clock	600 MHz
		Memory clock	400 MHz
		Frame buffer	256 MB DDR2 (128 bits wide)
	Languages supported	Czechoslovakian, Danis Hebrew, Hungarian, Itali	Arabic, Chinese Simplified, Chinese Traditional, h, Dutch, Finnish, French, German, Greek, an, Japanese, Korean, Norwegian, Polish, panish, Swedish, Thai, Turkish
	Core Power	25 W (Max board power	)
Option kit contents Compliance standards	<ul> <li>ATI Radeon X1300 Pro (256MB DH) PCIe Graphics Card with full height bracket attached</li> <li>DMS-59 Dual VGA <ul> <li>DMS-59 Dual VGA</li> <li>NOTE: The Optional DMS-59 DVI cable can be ordered with HP Option Kit #DL139A</li> </ul> </li> <li>Software CD with graphics drivers</li> <li>Low profile bracket to convert the card for using in a low profile chassis</li> <li>Warranty documentation</li> </ul>		
	Compliance standards	<ul> <li>a) FCC Part 15, Subpart Computing Devices for H</li> <li>b) CISPR22: 1997/EN 55 measurement of radio di Technology Equipment</li> <li>c) Canadian Standard IC</li> <li>d) Taiwanese Standard IC</li> <li>e) Japanese VCCI</li> <li>f) Australian C-Tick</li> <li>g) Korean (MIC)</li> </ul>	5022:1998 – Class B – Limits and methods of isturbance characteristics of Information CES-003 is equivalent to CISPR22
			24:1998 – Information Technology Equipment – s – Limits and Methods of Measurement.
			0950 (EU): Safety of Information Technology ectrical Business Equipment. All boards meet quirements.



### Technical Specifications - Input Devices

HP PS/2 or USB Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
		Dimensions (L x W x H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)
		Weight	2 lb (0.9 kg) minimum
	Electrical	Operating voltage	+ 5VDC ± 5%
		Power consumption	50-mA maximum (with three LEDs ON)
		ESD	CE level 4, 15-kV air discharge
		EMI – RFI	Conforms to FCC rules for a Class B computing device
		MicrosoftPC 99 – 2001	Functionally compliant
	Mechanical	Languages	38 available
		Keycaps	Low-profile design
		Switch actuation	55-g nominal peak force with tactile feedback
		Switch life	20 million keystrokes (using Hasco modified tester)
		Switch type	Contamination-resistant switch membrane
		Key-leveling mechanisms	For all double-wide and greater-length keys
		Cable length	6 ft (1.8 m)
		Microsoft PC 99 – 2001	Mechanically compliant
		Acoustics	43-dBA maximum sound pressure level
	Environmental	Operating temperature	50° to 122° F (10° to 50° C)
		Non-operating temperature	-22° to 140° F (-30° to 60° C)
		Operating humidity	10% to 90% (non-condensing at ambient)
		Non-operating humidity	20% to 80% (non-condensing at ambient)
		Operating shock	40 g, six surfaces
		Non-operating shock	80 g, six surfaces
		Operating vibration	2-g peak acceleration
		Non-operating vibration	4-g peak acceleration
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
		<b>Drop</b> (in box)	42 in (107 cm) on concrete, 16-drop sequence
	Approvals	UL, CSA, FCC, CE Mark,	TUV, TUV GS, VCCI, BSMI, C-Tick, MIC
	Ergonomic compliance	ANSI HFS 100, ISO 9241	-4, and TUVGS



### Technical Specifications - Input Devices

HP 2-Button Scroll Mouse (PS/2)	Scroll Wheel Maximum Rotation	8 mm 30 mm/s	
	Speed	List franzistan stran	
	Switch Type	Light force micro-switch	
	Switch Life	1 million operations	
	Mechanical Life	Minimum 200,000 revolu	
	Environmental		50° to 122° F (10° to 50° C)
		Non-operating Temperature	-22° to 140° F (-30° to 60° C)
		Operating Humidity	10% to 90% (non condensing at ambient)
		Non-operating Humidity	20% to 80% (non condensing at ambient)
		Operating Shock	40 g, 6 surfaces
		Non-operating Shock	80 g, 6 surfaces
		<b>Operating Vibration</b>	2 g peak acceleration
		Non-operating Vibration	4 g peak acceleration
	Electrical	Operating Voltage	+ 5VDC ± 10%
		Power Consumption	15mA
		System Consumption	PS/2 mini-din connector
		ESD	CE level 4, 15 kV air discharge
		EMI-RFI	Conforms to FCC rules for a Class B computing device
		PC98	Functionally compliant
	Mechanical	Resolution	400 ± 20% DPI
		Tracking Speed	10 in/s maximum
		Acceleration	100 in/s
		Switch Actuation	85 g nominal peak force
		Switch Life	1,000,000 operations (using Hasco modified tester)
		Cable Length	2 m
		PC98-99	Mechanically compliant
	Regulatory Approvals	UL, CSA, FCC, CE Mark	, TUV, TUV GS, VCCI, BCIQ, C-Tick



Technical Specifications - Hard Drives

Serial ATA Hard Drives	80 GB	Capacity	80,026,361,856 bytes	
(7200 rpm)		Height	1 in (2.6 cm)	
		Width	Media diameter: 3.5 in (8 Physical size: 4 in (10.2 c	,
		Interface	Serial ATA	
		Synchronous Transfer Rate (Maximum)	1.5 Gb/s	
		Buffer	8 MB	
		Seek Time (typical	Single Track	1.0 ms
		reads, includes controller	Average	8.5 ms
		overhead, including settling)	Full-Stroke	18 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	156,301,488	
		<b>Operating Temperature</b>	32° to 140° F (0° to 60° 0	C)
	160 GB	Capacity	160,041,885,696 bytes	
		Height	1 in (2.6 cm)	
		Width	Media diameter: 3.5 in (8 Physical size: 4 in (10.2 c	,
		Interface	Serial ATA	
		Synchronous Transfer Rate (Maximum)	1.5 Gb/s	
		Buffer	8 MB	
		Seek Time (typical	Single Track	1.0 ms
	reads, includes controller	Average	8.5 ms	
		overhead, including settling)	Full-Stroke	18 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	312,581,808	
		<b>Operating Temperature</b>	32° to 140° F (0° to 60° 0	C)



### Technical Specifications - Hard Drives

250 GB

Capacity	250,059,350,016 bytes	
Height	1 in (2.6 cm)	
Width	Media diameter: 3.5 in (8 Physical size: 4 in (10.2	,
Interface	Serial ATA	
Synchronous Transfer Rate (Maximum)	1.5 Gb/s	
Buffer	8 MB	
Seek Time (typical	Single Track	0.8 ms
reads, includes controller overhead, including	Average	<9.0 ms
settling)	Full-Stroke	=17 ms
Rotational Speed	7,200 rpm	
Logical Blocks	488,397,168	
	41° to 131° F (5° to 55°	$\sim$



### Technical Specifications - Optical Storage

SATA DVD-ROM Drive	Height	5.25-inch, half-height, tra	v-load	
	Orientation	Either horizontal or vertical		
	Interface type	SATA/ATAPI	a	
	Disc capacity	Single layer: Up to 4.7 GB (6 times capacity of CD-ROM) Double layer: Up to 8.5 GB (12 times capacity of CD-ROM		,
				D-ROM)
	, ,	) 5.9 x 1.7 x 8.0 in (15.0 x	4.4 X 20.3 CM)	
	Weight (max)	2.6 lb (1.2 kg)		
	Read speeds	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		DVD-RAM	Up to 4X	
		CD-ROM, CD-R	Up to 48X	
		CD-RW	Up to 32X	
	Removable Storage -	Media	Read	Write
	Media Compatibility - DVD-ROM	CD-ROM	Yes	No
		CD-R	Yes	No
		CD-RW	Yes	No
		DVD-ROM	Yes	No
		DVD-ROM DL	Yes	No
		DVD-RAM	Yes	No
		DVD+R	Yes	No
		DVD+R DL	Yes	No
		DVD+RW	Yes	No
		DVD-R	Yes	No
		DVD-RW	Yes	No
		DVD-R DL	Yes	No
	Access times (typical reads, including setting)	Random	DVD: < 140 ms (typical), CD: < 125 ms (typical)	
		Full Stroke	DVD: < 250 ms (seek), CD: < 210 ms (seek)	
		Cache Buffer	2 MB (minimum)	
		Data Transfer Modes	ATA PIO mode 4 (16.7 M DMA mode 2 (16.7 MB/s Mode 3 (44.4 MB/s -defa	); ATA UltraDMA
	Power	Source	SATA DC power recepta	cle
		DC Power Requirement	5 VDC ± 5%-100 mV ripp 12 VDC ± 5%-200 mV rip	
		DC Current	5 VDC - <1000 mA typica maximum 12 VDC -< 600 mA typica maximum	
	Environmental	Temperature	41° to 122° F (5° to 50°	C)
	(all conditions	Relative Humidity	10% to 90%	
	non-condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	



Technical Specifications - Optical Storage

SATA CD-RW/DVD-	Height	5.25-inch, half-height, tra	y-load	
ROM Combo Drive	Orientation	Either horizontal or vertic	al	
	Interface type	SATA/ATAPI		
	Disc capacity	Single layer: Up to 4.7 GB (6 times capacity of CD-ROM) Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)		
	Dimensions (W x H x D)	) 5.9 x 1.7 x 8.0 in (15.0 x	4.4 x 20.3 cm)	
	Weight (max)	2.6 lb (1.2 kg)		
	Write speeds	CD-R	Up to 48X	
		CD-RW	Up to 32X	
	Read speeds	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		CD-ROM, CD-R	Up to 48X	
		CD-RW	Up to 32X	
	Access times (typical reads, including	Random	DVD: < 140 ms (typical), CD: < 125 ms (typical)	
	setting)	Full Stroke	DVD: < 250 ms (typical), CD: < 210 ms (typical)	
	Power	Source	SATA DC power receptacle	
		DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p	
		DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum 12 VDC -< 600 mA typical, < 1400 mA maximum	
	Environmental	Temperature	41° to 122° F (5° to 50° C)	
	(all conditions	Relative Humidity	10% to 90%	
	non-condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	



1	, ,	5	
SATA DVD+/-RW	Height	5.25-inch, half-height, trag	y-load
LightScribe Drive	Orientation	Either horizontal or vertical	
	Interface type	SATA/ATAPI	
	Disc capacity	Single layer: Up to 4.7 GB (6 times capacity of CD-ROM) Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)	
	Dimensions (W x H x D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)		
	Weight (max)	2.6 lb (1.2 kg)	
	Write speeds	DVD+R	Up to 16X
		DVD+RW	Up to 8X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 4X
		DVD-R	Up to 16X
		DVD-RW	Up to 6X
		CD-R	Up to 48X
		CD-RW	Up to 32X
	Read speeds	DVD-RAM	Up to 4X
		DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X
		DVD-ROM	Up to 16X
		CD-ROM, CD-R	Up to 48X
		CD-RW	Up to 32X
	Access times (typical reads, including	Random	DVD: < 130 ms (typical), CD: < 120 ms (typical)
	setting)	Full Stroke	DVD: < 240 ms (seek), CD: < 200 ms (seek)
	Power	Source	SATA DC power receptacle
		DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p
		DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum 12 VDC -< 600 mA typical, < 1400 mA maximum
	Environmental (all conditions	Temperature	41° to 122° F (5° to 50° C)
		Relative Humidity	10% to 90%
	non-condensing)	Maximum Wet Bulb Temperature	86° F (30° C)

### Technical Specifications - Optical Storage



### Technical Specifications - Removable Storage

HP 1.44-MB Diskette	Size	3.5 in (8.89 cm)	
Drive	LED Indicators (front panel)	Green	
	Read/Write Capacity per Diskette (high/low)	1.44 MB/720 KB	
	Drive Height	One-third	
	Drive Rotation	300 rpm	
	Transfer Rate (high/low)	500/250 KB/s	
	Bytes/Sector	512	
	Sectors/Track (high/low)	18/9	
	Tracks/Side (high/low)	80/80	
	Access Times	Track-to-Track (high/low)	) 3/6 ms
		Average (high/low)	94/173 ms
		Settling Time	15 ms
		Latency Average	100 ms
	Cylinders (high/low)	80/80	
	Read/Write Heads	Two	
HP 16-in-1 Media Card Reader	USB interface	USB 2.0 High-speed device via PCI card or pass -through via internal USB port of system board	
	Advance protocol support	<ul> <li>Supports hardware ECC (Error Correction Code) function</li> <li>Supports hardware CRC (Cyclic Redundancy Check) function</li> <li>Supports MS 4-bit parallel transfer mode</li> <li>Supports MS-PRO 4-bit parallel transfer mode</li> <li>Supports SD 4-bit parallel transfer mode</li> <li>Supports high-speed 50 MHz SD 4-bit card (version 1.1)</li> <li>Support high-speed 52 MHz MMC 8-bit card (version 4.x)</li> </ul>	
	Maahaniaal	Length (3.5")	124.7 cm
	Mechanical	• • •	
	Mechanical	Width (3.5")	101.6 cm
	wechanicai	• • •	
	Mechanical	Width (3.5")	101.6 cm
	wechanicai	Width (3.5") Height (3.5")	101.6 cm 25.4 cm



Technical Specifications - Removable S	Storage	
Environmental	Operational environmental extremes	Test Parameters/Conditions - Power applied, unit operating on system $\pm$ 5% nominal supply voltage. 10°C 10% R.H. = 24 hours 10°C 90% R.H. = 24 hours 20°C 90% R.H. = 24 hours 30°C 90% R.H. = 24 hours 40°C 90% R.H. = 24 hours 50°C 90% R.H. = 24 hours 50°C 10% R.H. = 24 hours
	Storage environmental extremes	Test Parameters/Conditions 60°C @ 80% R.H. for 96 hours -30°C @ 20% R.H. for 48 hours No power applied Delta °C < 1.0°C/min Delta % R.H. < 1.5% R.H./min
Approvals	Transport Specification F Connectivity Design Gui	ant with USB Mass Storage Class Bulk only Rev. 1.0, Compliant Intel Front Panel I/O de V. 1.2 VCCI, MIC, cUL, TUV-T



#### Technical Specifications - Environmental Data

Eco-Label	This product has received or is in the process of being certified to the following approvals and may
Certifications &	be labeled with one or more of these marks:
declarations	

- US Energy Star\*
- US Federal Energy Management Program (FEMP)
- Taiwan Green Mark
- China Energy Conservation Program
- IT ECO declaration
- EPEAT
- Korea Ecolabel

### \* Compliant with Energy Star 3.0; not compliant with Energy Star 4.0 when those requirements take effect

Longevity and Upgrading

This product is designed to be upgraded, possibly extending its useful life by several years. Spare parts are available throughout the warranty period and for up to 15 months after the end of production. Upgradeability features contained in the product include:

- 6 external USB ports
- 2 internal USB ports
- 2 external 5.25" drive bays
- 2 internal 3.5" drive bays
- 1 external 3.5" drive bay
- 1 empty standard PCI slot
- 2 empty standard PCIe x1 slots
- 1 empty standard PCIe x16 slot
- 2 memory slots
- 1 Serial port
- 1 Optional second serial port
- 1 Parallel port

Spare parts are available throughout the warranty period and for up to 5 years after the end of production.

**Batteries** 

This product complies with ISO standards:

- EU Directive 91/ 157/ EEC
- EU Directive 93/86/EEC
- EU Directive 98/ 101/ EEC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell) Battery type: Lithium



### Technical Specifications - Environmental Data

Additional Information	<ul> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS)</li> </ul>
	<ul> <li>directive – 2002/95/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe</li> </ul>
	Drinking Water and Toxic Enforcement Act of 1986).
	<ul> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.</li> </ul>
	<ul> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level, see</li> </ul>
	http://www.epeat.net
	Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and
	<ul><li>ISO1043.</li><li>This product contains 0% recycled materials (by wt.)</li></ul>
	<ul> <li>This product is &gt;90% recyclable when properly disposed of at end of life.</li> </ul>
	Packaging Materials
	<ul> <li>Corrugated Paper – TBD g</li> <li>EPE Foam – TBD g</li> </ul>
	<ul> <li>EFE FOATT = TBD g</li> <li>LDPE Bag -TBD g</li> </ul>
	The EPE foam packaging material is made from 30–60% recycled content.
	The corrugated paper packaging materials contains at least 80% recycled content.
RoHS Compliance	Hewlett-Packard is committed to compliance with all applicable environmental laws and
	regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive
	on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to
	levels below legal limits) for all HP electronic products subject to the RoHS Directive, except
	where it is widely recognized that there is no technically feasible alternative (as indicated by an
	exemption under the EU RoHS Directive).
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at
	http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):
	Asbestos     Colorante
	<ul> <li>Certain Azo Colorants</li> <li>Certain Brominated Flame Retardants – may not be used as flame retardants in plastics</li> </ul>
	<ul> <li>Cadmium</li> </ul>
	Chlorinated Hydrocarbons
	Chlorinated Paraffins
	Formaldehyde
	Halogenated Diphenyl Methanes
	<ul> <li>Lead carbonates and sulfates</li> <li>Lead and Lead compounds</li> </ul>
	<ul> <li>Mercuric Oxide Batteries</li> </ul>
	<ul> <li>Nickel – finishes must not be used on the external surface designed to be frequently</li> </ul>
	handled or carried by the user.
	Ozone Depleting Substances
	<ul> <li>Polybrominated Biphenyls (PBBs)</li> </ul>
	Polybrominated Biphenyl Ethers (PBBEs)
	Polybrominated Biphenyl Oxides (PBBOs)     Polyblarinated Biphenyl (DCB)
	<ul> <li>Polychlorinated Biphenyl (PCB)</li> <li>Polychlorinated Tempeovyls (PCT)</li> </ul>
	<ul> <li>Polychlorinated Terphenyls (PCT)</li> <li>Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has</li> </ul>
	<ul> <li>Polyviny Chonce (PVC) – exception wires and cables, and certain retain packaging has been voluntarily removed from most applications</li> </ul>



Technical Specifications - E	Environmental Data
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	Radioactive Substances
	<ul> <li>Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)</li> </ul>
Packaging	HP follows these guidelines to decrease the environmental impact of product packaging:
	<ul> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <u>http://www.hp.com/recycle</u> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
Hewlett-Packard Corporate	For more information about HP's commitment to the environment:
Environmental	Global Citizenship Report
Information	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications
	http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html
	ISO 14001 certificates:
	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

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